

**PATENT ASSIGNMENT**

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Jae-Heon KIM	06/18/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Hynix Semiconductor Inc.
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<b>City:</b>	Icheon-si, Kyoungki-do
<b>State/Country:</b>	REPUBLIC OF KOREA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12163901
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<b>ATTORNEY DOCKET NUMBER:</b>	00939C-170200US
<b>NAME OF SUBMITTER:</b>	Evelyn D. Jackson
<b>Total Attachments: 1</b> source=00939C-170200US-ASN#page1.tif	

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**ASSIGNMENT OF PATENT APPLICATION**

SOLE

WHEREAS, the below-listed individual, herein referred to as "Assignor," is the inventor of the invention described and set forth in the following application for United States Letters Patent:

**METHOD OF FORMING CONTACT PLUG OF SEMICONDUCTOR DEVICE**

Filed June 27, 2008, as U.S. Application No. 12/163,901

WHEREAS, **Hynix Semiconductor Inc., of San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, Republic of Korea**, hereinafter referred to as "Assignee," is desirous of acquiring an interest in the invention and application and in any U.S. Letters Patent and Registrations which may be granted on the same;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has assigned, and by these presents does assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on any patent application claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees that Assignor will, without charge to Assignee, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Assignor hereby authorizes and requests Townsend and Townsend and Crew LLP, Two Embarcadero Center, 8th Floor, San Francisco, California 94111-3834, to insert hereinabove the application number and filing date of said application when known.

IN TESTIMONY WHEREOF, Assignor has signed his/her name on the date indicated.

Date: June 18, 2008



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Name: Jae Heon KIM